OXFORD INNOTECH BERHAD
Registration No. 202101035217 (1435517-T)

PRESS STATEMENT/ SIARAN AKHBAR
(FOR IMMEDIATE RELEASE)

OXFORD INNOTECH'S 2QFY26 NET PROFIT SURGES 162.5% YOY TO RM4.2 MILLION ON SEMICONDUCTOR DATA CENTRE AND E&E CONTRIBUTIONS

~ Purchase new machines to support robust order backlog of RM38.9 million as at 30 June 2026

Kuala Lumpur, 21 August 2026 – Integrated engineering solutions provider, Oxford Innotech Berhad ("OXB" or the "Group") (牛津科创有限公司), has today announced its second quarter ("2QFY26") and first half ("1HFY26") financial results for the period ended 30 June 2026.

The Group delivered revenue of RM24.5 million in 2QFY26, representing 43.7% year-on-year ("YoY") growth from RM17.1 million in the corresponding quarter of preceding year ("2QFY25"). This was mainly driven by higher deliveries to customers in the semiconductor, data centre and electrical and electronics ("E&E") industries.

By business segment, precision engineering components solutions accounted for RM17.3 million, or 70.5% of the total revenue in 2QFY26, followed by mechanical assembly solutions at RM6.6 million (26.9%) and automation and robotics solutions at RM0.6 million (2.6%).

Geographically, Malaysia remained the Group's largest market, contributing 63.2% of 2QFY26 revenue, while export markets accounted for the remaining 36.8%, mainly comprising other Asian countries, North America and Europe.

Meanwhile, profitability grew at a faster pace than revenue, with profit after tax ("PAT") surging 162.5% YoY to RM4.2 million from RM1.6 million in 2QFY25. This was supported by the improved topline performance, coupled with the absence of one-off listing expenses incurred in 2QFY25.

For 1HFY26, revenue increased 15.7% YoY to RM42.4 million from RM36.6 million in the corresponding preceding period ("1HFY25"), while PAT expanded at a stronger pace of 53.5% YoY to RM7.4 million from RM4.8 million. PAT margin also improved to 17.5%, compared with 13.2% in 1HFY25.

Managing Director of OXB, Mr. Ng Thean Gin (黄天仁), commented, “We are encouraged by the progress made over the past year, with our qualification efforts now translating into consistent mass production orders. This provides greater order visibility for the Group as we continue to execute existing orders while building the capacity needed to support customers’ growing requirements.”

As at 30 June 2026, the Group’s order backlog stood at RM38.9 million, up from RM30.0 million as at 31 March 2026.

“Between June and July 2026, we received three purchase orders with an aggregate value of RM8.8 million from a United States-based semiconductor customer. The Group also secured repeat orders from its data centre customer after successfully delivering earlier projects, reflecting continued customer confidence in OXB’s execution and delivery capabilities.”

To support the growing order pipeline and future production requirements, OXB has commenced construction of its Penang Science Park Factory 2 Phase 2 in early June 2026. Targeted for completion in the second half of 2027, the expansion is expected to increase the Group’s total manufacturing space by 50.2% to approximately 202,696 sq. ft. In parallel, the Group is acquiring 34 new machines, which are expected to progressively commence operations in 2HFY26.

“The additional manufacturing space and machinery will strengthen our ability to fulfil the growing demand of our semiconductor and data centre customers while providing additional capacity for future opportunities. With the robust order visibility, an expanding customer base and proven technical capabilities, we believe OXB is well positioned to participate in the continued growth of these industries,” Mr. Ng concluded.

-end-

About Oxford Innotech Berhad

Headquartered in Penang, Oxford Innotech Berhad ("**OXB**") (stock code: OXB/0368), through its subsidiaries, is an integrated engineering solutions provider specialising in precision engineering components solutions, mechanical assembly solutions, and automation and robotic solutions. OXB's customers comprise primarily multinational and local manufacturers and assemblers across various industries, including semiconductor, electrical and electronics, automotive, and modular building systems.

For more information, please visit https://oxfordinnotech.com/

Released on behalf of Oxford Innotech Berhad by Capital Front Investor Relations.

MEDIA CONTACT:
Evon Tan
(E) evon@capitalfront.biz